

# HAT2266H

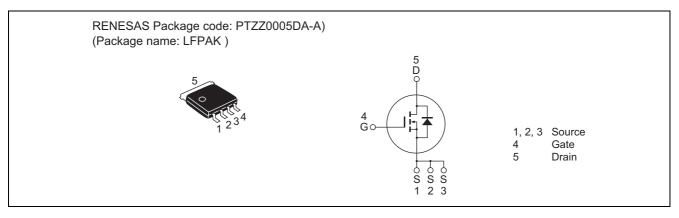
Silicon N Channel Power MOS FET Power Switching

> REJ03G1370-0500 Rev.5.00 Apr 05, 2006

### Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
  - $R_{DS(on)} = 9.2 \text{ m}\Omega \text{ typ.}$  (at  $V_{GS} = 10 \text{ V}$ )
- Lead Free

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	30	A
Drain peak current	Note1 I <sub>D(pulse)</sub>	120	A
Body-drain diode reverse drain current	I <sub>DR</sub>	30	A
Avalanche current	I <sub>AP</sub> Note 2	20	A
Avalanche energy	E <sub>AR</sub> Note 2	34	mJ
Channel dissipation	Pch Note3	23	W
Channel to Case Thermal Resistance	θch-C	5.44	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	C°

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at Tch =  $25^{\circ}$ C, Rg  $\geq 50 \Omega$ 

3. Tc = 25°C



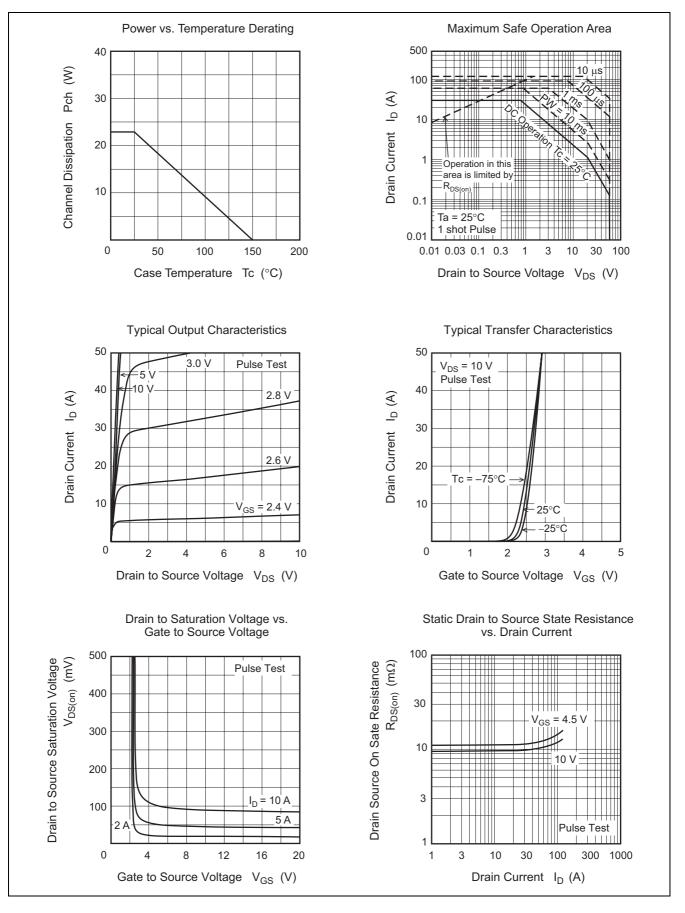
# **Electrical Characteristics**

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	60	_	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>			1	μΑ	$V_{DS} = 60 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.0	_	2.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Static drain to source on state	R <sub>DS(on)</sub>		9.5	12	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R <sub>DS(on)</sub>		11	16	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y <sub>fs</sub>	35	70	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	3600	_	pF	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz
Output capacitance	Coss	_	400	_	pF	
Reverse transfer capacitance	Crss	_	145	_	pF	
Gate resistance	Rg		0.5	_	Ω	
Total gate charge	Qg	_	25	_	nC	$V_{DD} = 25 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$ $I_D = 30 \text{ A}$
Gate to source charge	Qgs		8.2	_	nC	
Gate to drain charge	Qgd		9	_	nC	
Turn-on delay time	t <sub>d(on)</sub>	_	10	—	ns	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \ V, \ I_{D} = 15 \ A, \\ V_{DD} \cong 30 \ V, \ R_{L} = 2 \ \Omega, \\ Rg = 4.7 \ \Omega \end{array}$
Rise time	tr		15	_	ns	
Turn-off delay time	t <sub>d(off)</sub>		50	_	ns	
Fall time	t <sub>f</sub>		5.5	_	ns	
Body–drain diode forward voltage	V <sub>DF</sub>	_	0.84	1.10	V	$I_F = 30 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-drain diode reverse recovery	t <sub>rr</sub>	_	40	_	ns	$I_F = 30 \text{ A}, V_{GS} = 0,$
time						di <sub>F</sub> / dt = 100 A/ μs

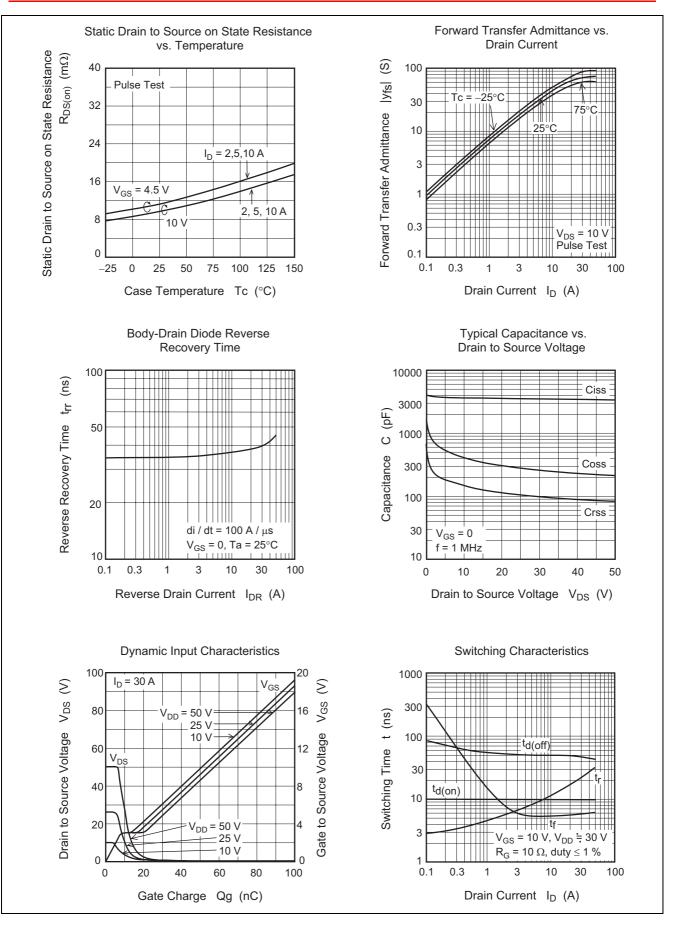
Notes: 4. Pulse test



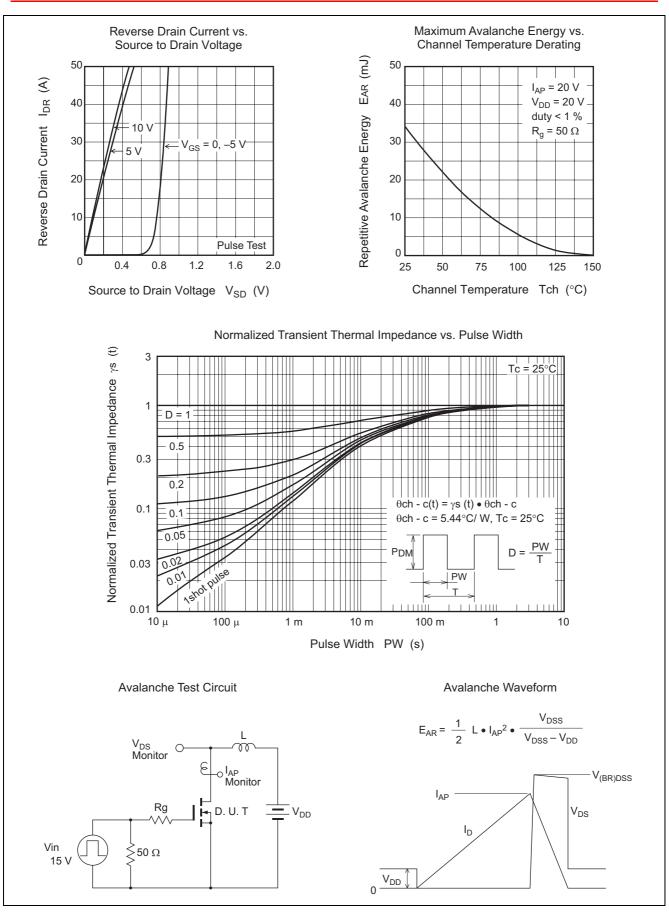
### **Main Characteristics**



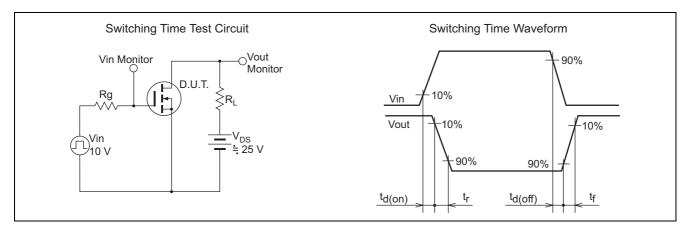






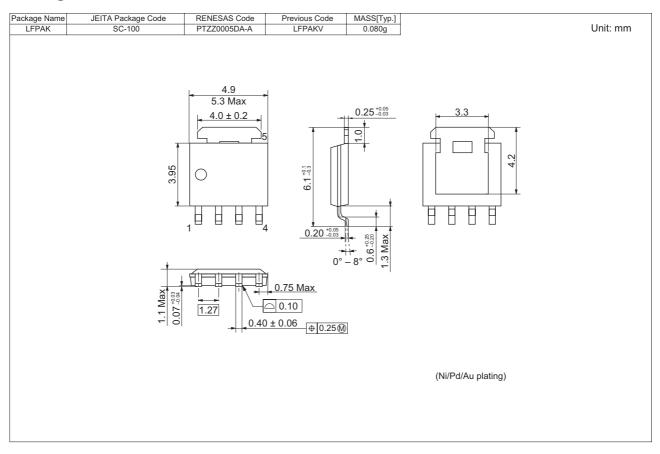








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2266H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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